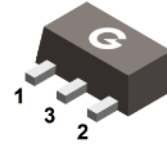
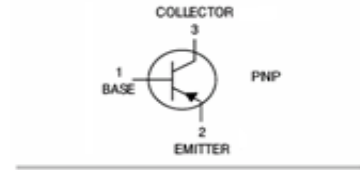


Features

- Epitaxial planar die construction
- Complimentary to 2SD1664
- Ultra-small surface mount package
- RoHS compliant with Halogen-free

HF



SOT-89

Mechanical Data

- Case: SOT-89
- Molding compound: UL flammability classification rating 94V-0
- Terminals: Tin-plated; solderability per MIL-STD-202, Method 208

Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
2SB1132-P	SOT-89	1000 pcs / Tape & Reel	BAP
2SB1132-Q	SOT-89	1000 pcs / Tape & Reel	BAQ
2SB1132-R	SOT-89	1000 pcs / Tape & Reel	BAR

Maximum Ratings (@ T_A = 25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Collector-Base Breakdown Voltage	V _{CBO}	-40	V
Collector-Emitter Breakdown Voltage	V _{CEO}	-32	V
Emitter-Base Breakdown Voltage	V _{EBO}	-5	V
Continuous Collector Current	I _C	-1	A
Peak Collector Current (t _p ≤ 1ms)	I _{CM}	-2	A

Thermal Characteristics

Parameter	Symbol	Value	Unit
Power Dissipation (T _A = 25°C) *1	P _D	500	mW
Thermal Resistance Junction-to-Air *1	R _{θJA}	250	°C/W
Power Dissipation (T _A = 25°C) *2	P _D	2	W
Thermal Resistance Junction-to-Air *2	R _{θJA}	62.5	°C/W
Thermal Resistance Junction-to-Case	R _{θJC}	18	°C/W
Operating junction Temperature	T _J	-55 ~ +150	°C
Storage Temperature Range	T _{STG}	-55 ~ +150	°C

Notes:

1. The data tested by surface mounted on a minimum recommended FR-4 board
2. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper

Electrical Characteristics (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	$I_C = -50\mu\text{A}, I_E = 0$	-40	-	-	V
Collector-Emitter Breakdown Voltage	$V_{(BR)CEO}$	$I_C = -1\text{mA}, I_B = 0$	-32	-	-	V
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	$I_E = -50\mu\text{A}, I_C = 0$	-5	-	-	V
Collector Cut-off Current	I_{CBO}	$V_{CB} = -20\text{V}, I_E = 0$	-	-	-0.5	μA
Collector Cut-off Current	I_{EBO}	$V_{EB} = -4\text{V}, I_C = 0$	-	-	-0.5	μA
DC Current Gain	h_{FE}	$V_{CE} = -3\text{V}, I_C = -100\text{mA}$	82	-	390	-
Collector-emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = -500\text{mA}, I_B = -50\text{mA}$	-	-0.2	-0.5	V
Base-emitter Saturation Voltage	$V_{BE(sat)}$	$I_C = -500\text{mA}, I_B = -50\text{mA}$	-	-	-1.0	V
Transition Frequency	f_T	$I_C = -50\text{mA}, V_{CE} = -5\text{V}$ $f = 30\text{MHz}$	-	150	-	MHz
Collector Output Capacitance	C_{OBO}	$V_{CB} = -10\text{V}, I_E = 0, f = 1\text{MHz}$	-	12	30	pF

Classification of h_{FE}

Rank	P	Q	R
Range	82-180	120-270	180-390
Marking	BAP	BAQ	BAR

Ratings and Characteristics Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

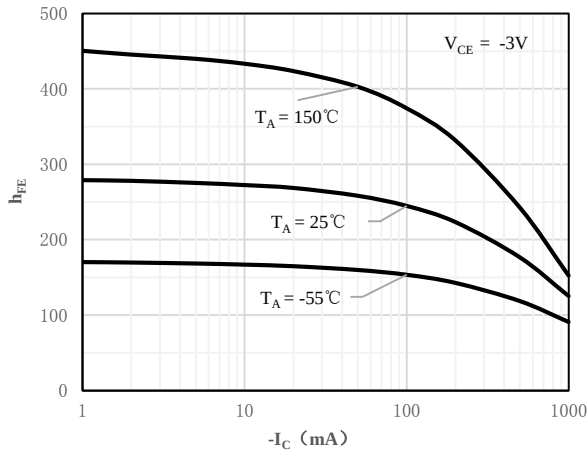


Fig 1 h_{FE} vs. I_C (R:160-320)

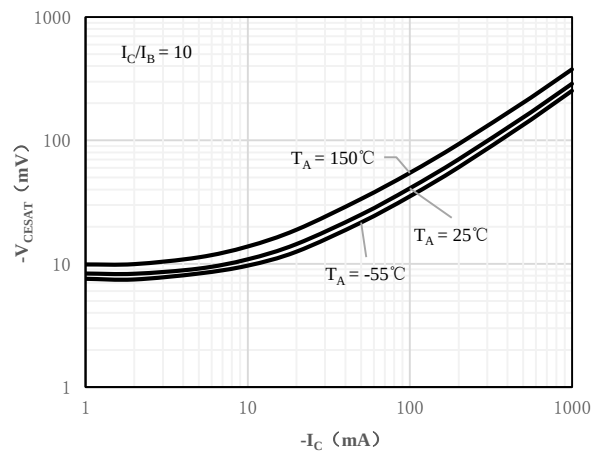


Fig 2 $V_{CE(sat)}$ vs. I_C

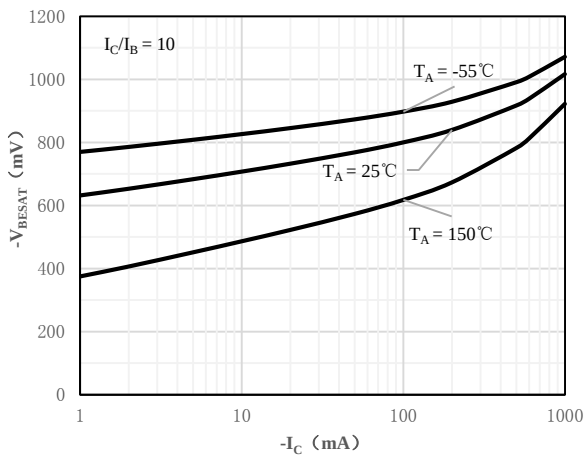


Fig 3 $V_{BE(sat)}$ vs. I_C

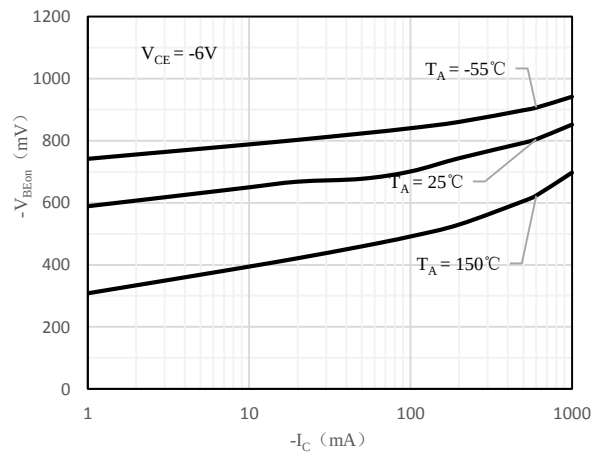


Fig 4 $V_{BE(on)}$ vs. I_C

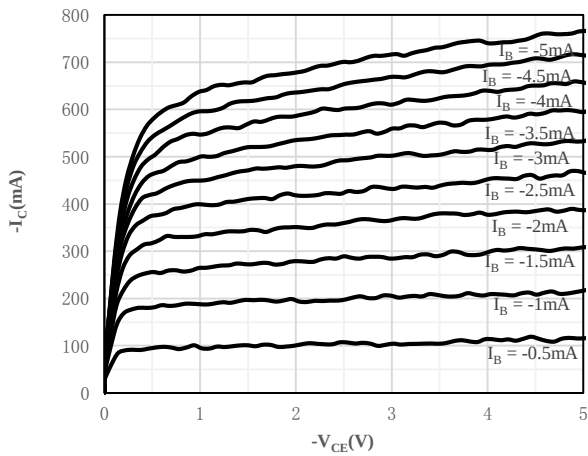


Fig 5 I_C vs. V_{CE}

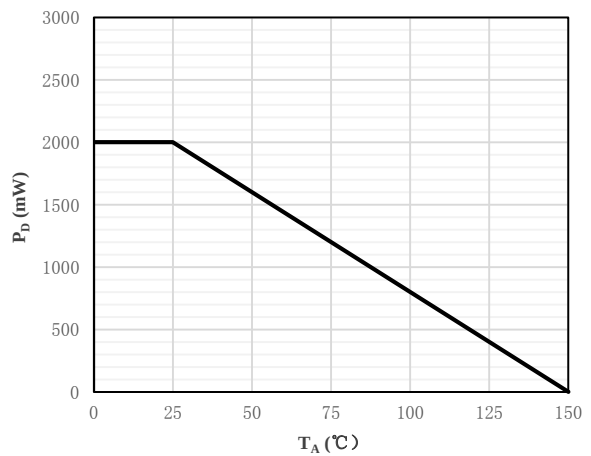


Fig 6 P_D vs. T_A

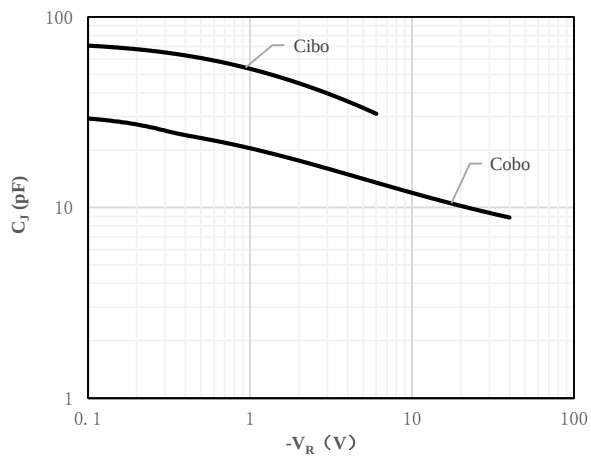
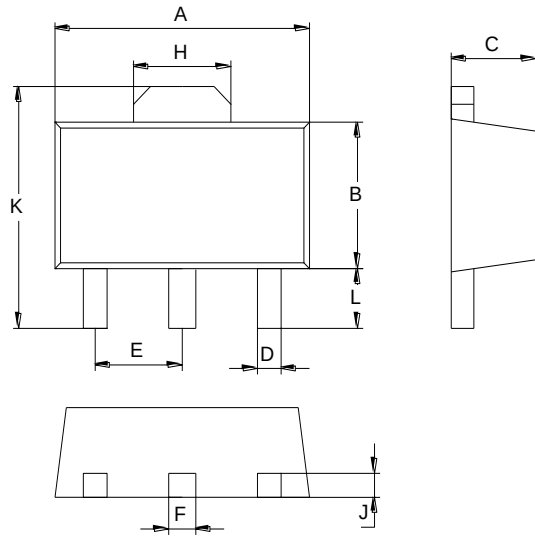


Fig 7 C_j vs. V_R

Package Outline Dimensions (Unit: mm)



SOT-89		
Dimension	Min.	Max.
A	4.30	4.70
B	2.25	2.65
C	1.30	1.70
D	0.30	0.50
E	1.40	1.60
F	0.38	0.58
H	1.60	1.80
J	0.30	0.50
L	0.90	1.10
K	3.95	4.35

Mounting Pad Layout (Unit: mm)

SOT-89

